

4/Pre-Amend A  
OKing  
7/3/01

ATTORNEY DOCKET NO. 43890-485  
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: )  
Hiroshi HAJI et al. ) Attn: APPLICATIONS BRANCH  
Serial No.: To Be Assigned )  
Filed: February 13, 2001 )  
For: METHOD OF MANUFACTURING )  
SEMICONDUCTOR DEVICE )

PRELIMINARY AMENDMENT

Hon. Assistant Commissioner for Patents  
Washington, DC 20231

Sir:

Prior to examination of the above-identified application, please amend the  
application as follows:

IN THE SPECIFICATION:

Please amend the specification as follows:

Page 1, line 6: after "device," insert --and--.

Page 2, line 9: after "right" insert --proper--.

Page 4, line 19: after "may be" insert --uniformly-- and delete "uniformly".

Page 5, line 2: change "the" (first occurrence) to --these--;

line 11: after "wafer 1" insert --to be--;